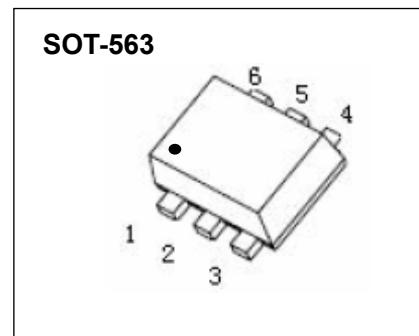




## SOT-563 Plastic-Encapsulate MOSFETS

### CJX3439K N Channel +P Channel MOSFET

$V_{(BR)DSS}$	$R_{DS(on)}MAX$	$I_D$
20V	380mΩ@ 4.5V	0.75A
	450mΩ@ 2.5V	
	800mΩ@ 1.8V	
-20V	520mΩ@ -4.5V	-0.66A
	700mΩ@ -2.5V	
	950mΩ(TYP)@ -1.8V	



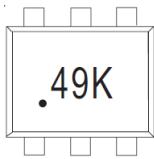
#### FEATURE

- Surface Mount Package
- Low  $R_{DS(on)}$
- Operated at Low Logic Level Gate Drive
- ESD Protected Gate
- Including a N-ch CJ3134K and a P-ch CJ3139K (independently) In a Package

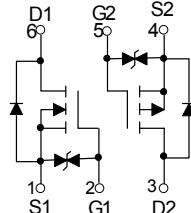
#### APPLICATION

- Load/ Power Switching
- Interfacing Switching
- Battery Management for Ultra Small Portable Electronics
- Logic Level Shift

#### MARKING



#### Equivalent Circuit



#### ABSOLUTE MAXIMUM RATINGS ( $T_a=25^\circ C$ unless otherwise noted)

Parameter	Symbol	Value	Unit
<b>N-MOSFET</b>			
Drain-Source Voltage	$V_{DS}$	20	V
Typical Gate-Source Voltage	$V_{GS}$	$\pm 12$	V
Continuous Drain Current (note 1)	$I_D$	0.75	A
Pulsed Drain Current ( $t_p=10\mu s$ )	$I_{DM}$	1.8	A
<b>P-MOSFET</b>			
Drain-Source Voltage	$V_{DS}$	-20	V
Typical Gate-Source Voltage	$V_{GS}$	$\pm 12$	V
Continuous Drain Current (note 1)	$I_D$	-0.66	A
Pulsed Drain Current ( $t_p=10\mu s$ )	$I_{DM}$	-1.2	A
<b>Temperature and Thermal Resistance</b>			
Thermal Resistance from Junction to Ambient (note 1)	$R_{\theta JA}$	833	°C/W
Junction Temperature	$T_J$	150	°C
Storage Temperature	$T_{STG}$	-55~+150	°C
Lead Temperature for Soldering Purposes(1/8" from case for 10 s)	$T_L$	260	°C

# MOSFET ELECTRICAL CHARACTERISTICS

## N-ch MOSFET ELECTRICAL CHARACTERISTICS( $T_a=25^\circ C$ unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
<b>STATIC CHARACTERISTICS</b>						
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	20			V
Zero gate voltage drain current	$I_{DSS}$	$V_{DS} = 20V, V_{GS} = 0V$			1	$\mu A$
Gate-body leakage current	$I_{GSS}$	$V_{GS} = \pm 10V, V_{DS} = 0V$			$\pm 20$	$\mu A$
Gate threshold voltage (note 2)	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	0.35		1.1	V
Drain-source on-resistance(note 2)	$R_{DS(on)}$	$V_{GS} = 4.5V, I_D = 0.65A$			380	$m\Omega$
		$V_{GS} = 2.5V, I_D = 0.55A$			450	$m\Omega$
		$V_{GS} = 1.8V, I_D = 0.45A$			800	$m\Omega$
Forward tranconductance(note 2)	$g_{FS}$	$V_{DS} = 10V, I_D = 0.8A$		1.6		S
Diode forward voltage	$V_{SD}$	$I_S = 0.15A, V_{GS} = 0V$			1.2	V
<b>DYNAMIC CHARACTERISTICS (note 4)</b>						
Input Capacitance	$C_{iss}$	$V_{DS} = 16V, V_{GS} = 0V, f = 1MHz$		79	120	pF
Output Capacitance	$C_{oss}$			13	20	pF
Reverse Transfer Capacitance	$C_{rss}$			9	15	pF
<b>SWITCHING CHARACTERISTICS (note 3,4)</b>						
Turn-on delay time	$t_{d(on)}$	$V_{GS} = 4.5V, V_{DS} = 10V, I_D = 500mA, R_{GEN} = 10\Omega$		6.7		ns
Turn-on rise time	$t_r$			4.8		ns
Turn-off delay time	$t_{d(off)}$			17.3		ns
Turn-off fall time	$t_f$			7.4		ns

## P-ch MOSFET ELECTRICAL CHARACTERISTICS( $T_a=25^\circ C$ unless otherwise noted)

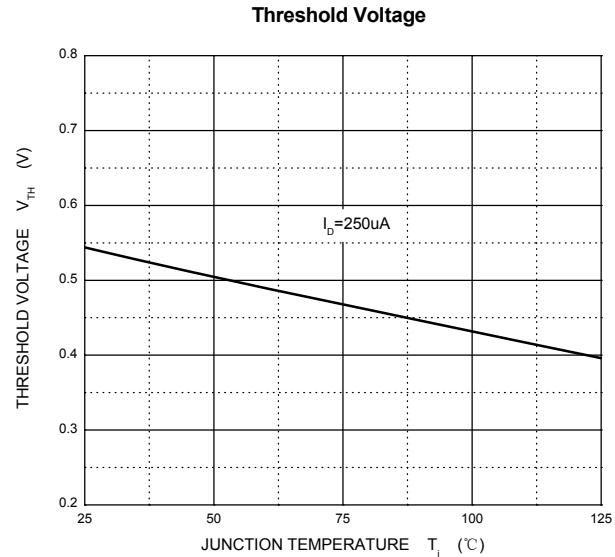
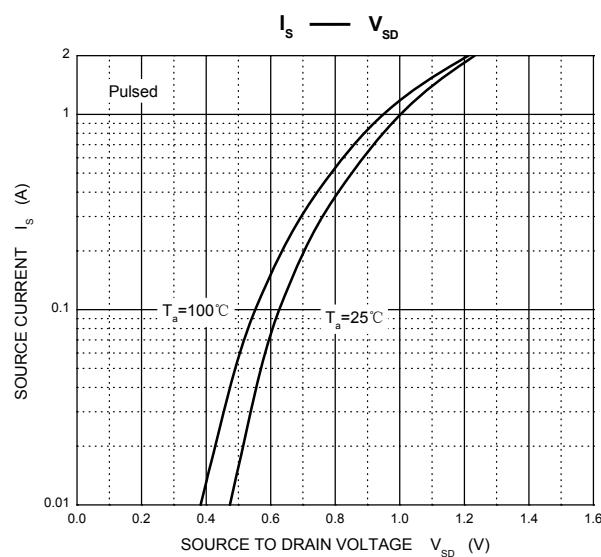
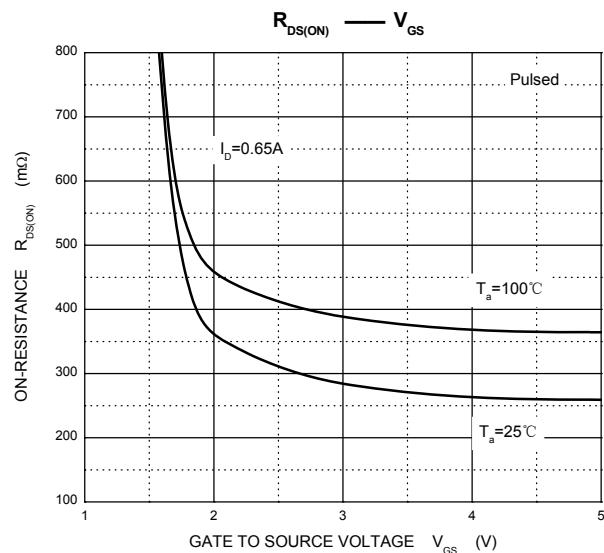
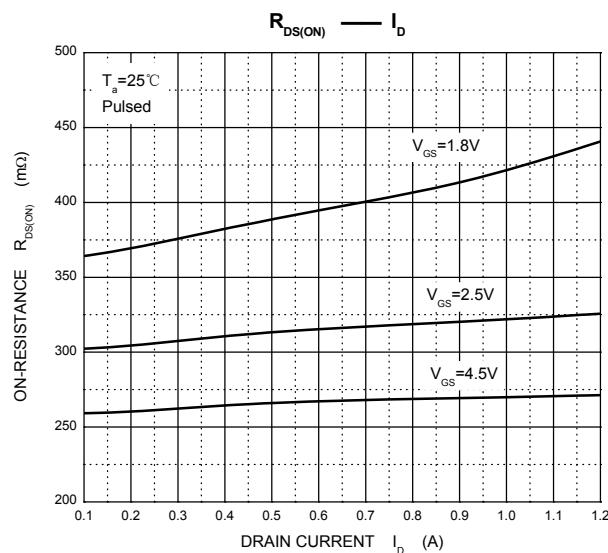
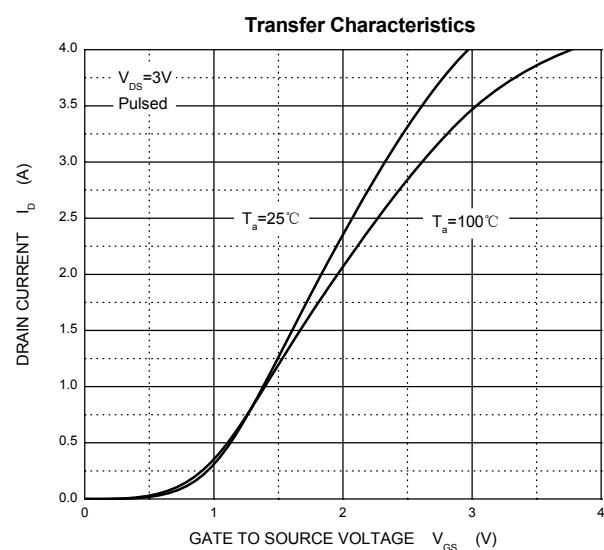
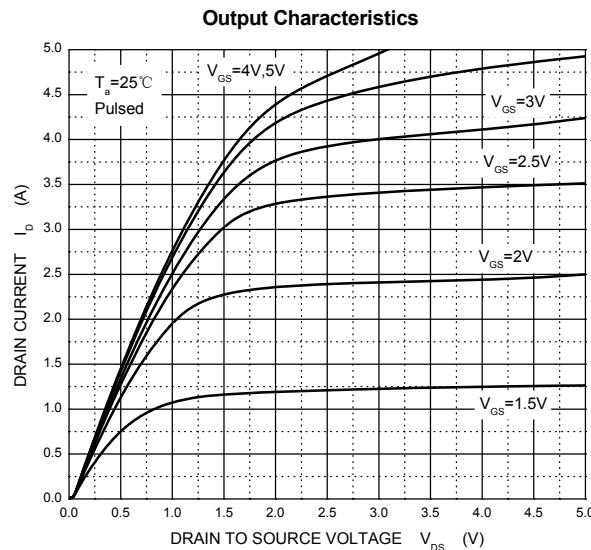
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
<b>STATIC CHARACTERISTICS</b>						
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = -250\mu A$	-20			V
Zero gate voltage drain current	$I_{DSS}$	$V_{DS} = -20V, V_{GS} = 0V$			-1	$\mu A$
Gate-body leakage current	$I_{GSS}$	$V_{GS} = \pm 10V, V_{DS} = 0V$			$\pm 20$	$\mu A$
Gate threshold voltage (note 2)	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -250\mu A$	-0.35		-1.1	V
Drain-source on-resistance(note 2)	$R_{DS(on)}$	$V_{GS} = -4.5V, I_D = -1A$			520	$m\Omega$
		$V_{GS} = -2.5V, I_D = -0.8A$			700	$m\Omega$
		$V_{GS} = -1.8V, I_D = -0.5A$			950	$m\Omega$
Forward tranconductance(note 2)	$g_{FS}$	$V_{DS} = -10V, I_D = -0.54A$		1.2		S
Diode forward voltage	$V_{SD}$	$I_S = -0.5A, V_{GS} = 0V$			-1.2	V
<b>DYNAMIC CHARACTERISTICS (note 4)</b>						
Input Capacitance	$C_{iss}$	$V_{DS} = -16V, V_{GS} = 0V, f = 1MHz$		113	170	pF
Output Capacitance	$C_{oss}$			15	25	pF
Reverse Transfer Capacitance	$C_{rss}$			9	15	pF
<b>SWITCHING CHARACTERISTICS (note 3,4)</b>						
Turn-on delay time	$t_{d(on)}$	$V_{GS} = -4.5V, V_{DS} = -10V, I_D = -200mA, R_{GEN} = 10\Omega$		9		ns
Turn-on rise time	$t_r$			5.8		ns
Turn-off delay time	$t_{d(off)}$			32.7		ns
Turn-off fall time	$t_f$			20.3		ns

### Notes :

1. Surface mounted on FR4 board using the minimum recommended pad size.
2. Pulse Test : Pulse width=300 $\mu s$ , duty cycle $\leq 2\%$ .
3. Switching characteristics are independent of operating junction temperature.
4. Guaranteed by design, not subject to producing.

## Typical Characteristics

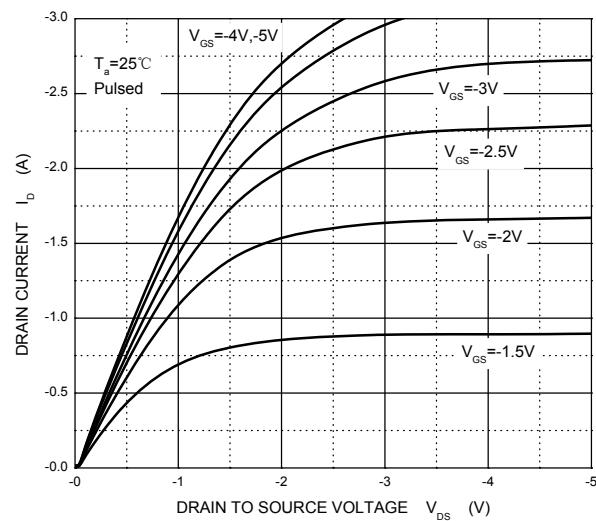
N-Channel MOS



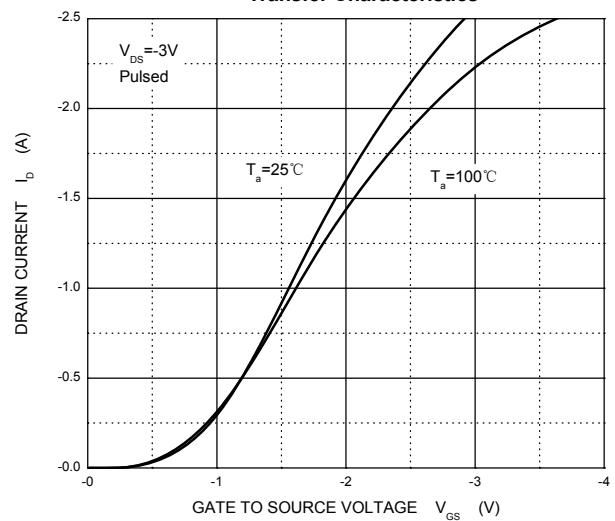
## Typical Characteristics

P-Channel MOS

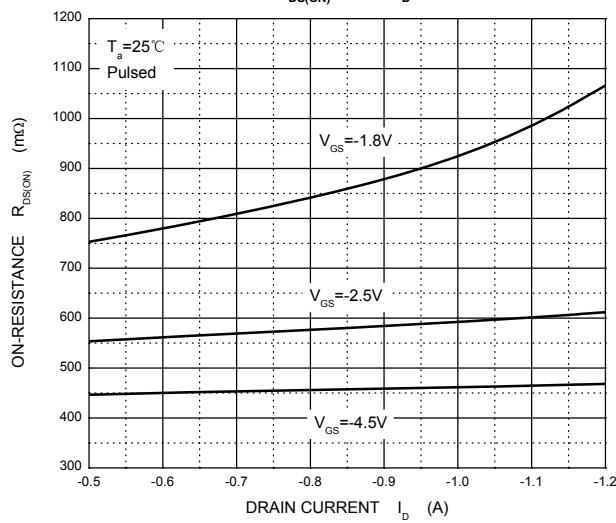
**Output Characteristics**



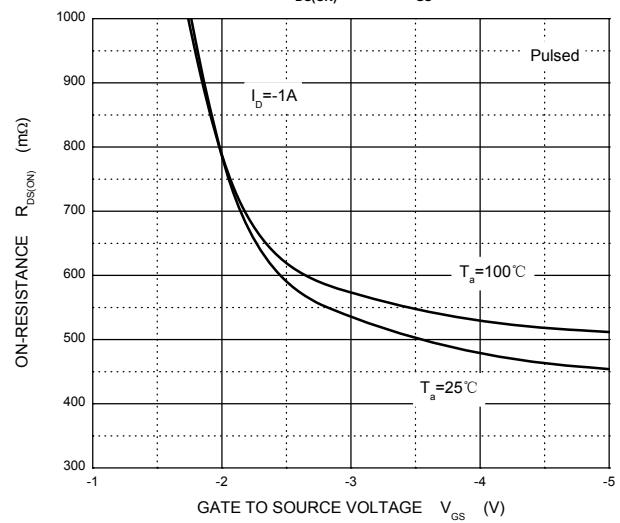
**Transfer Characteristics**



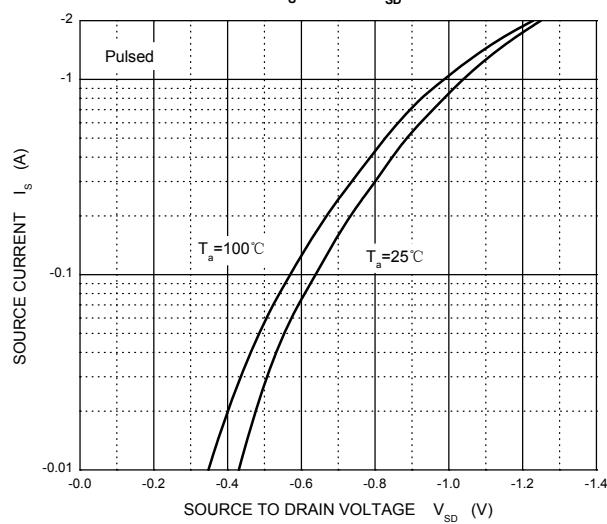
$R_{DS(ON)}$  —  $I_D$



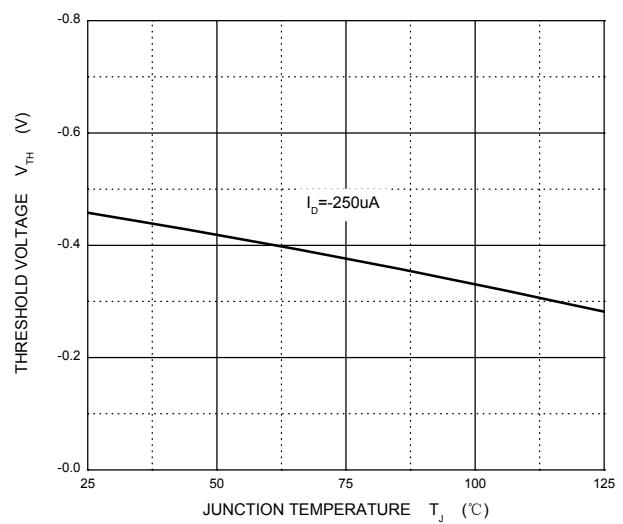
$R_{DS(ON)}$  —  $V_{GS}$



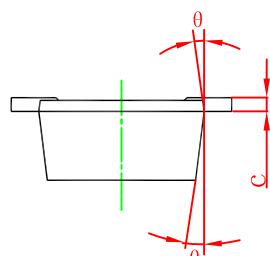
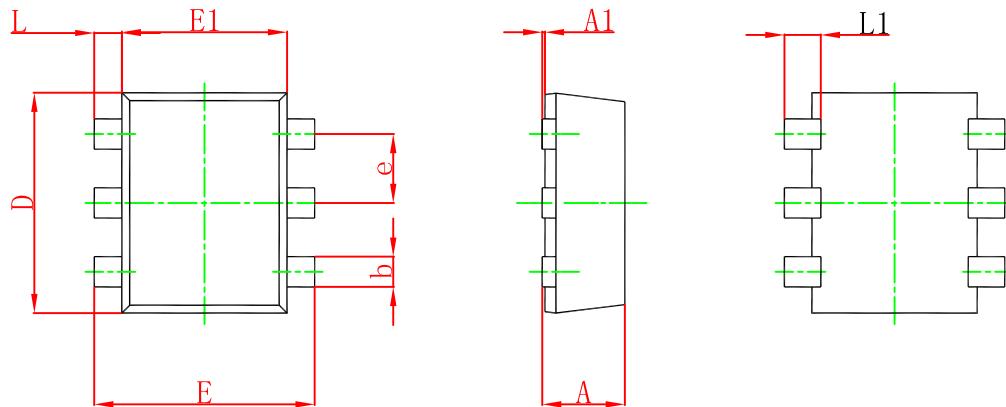
$I_S$  —  $V_{SD}$



**Threshold Voltage**

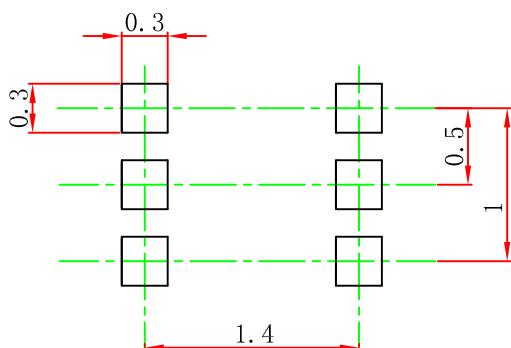


## SOT-563 Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.525	0.600	0.021	0.024
A1	0.000	0.050	0.000	0.002
e	0.450	0.550	0.018	0.022
c	0.090	0.160	0.004	0.006
D	1.500	1.700	0.059	0.067
b	0.170	0.270	0.007	0.011
E1	1.100	1.300	0.043	0.051
E	1.500	1.700	0.059	0.067
L	0.100	0.300	0.004	0.012
L1	0.200	0.400	0.008	0.016
$\theta$	$7^{\circ}$ REF.		$7^{\circ}$ REF.	

## SOT-563 Suggested Pad Layout



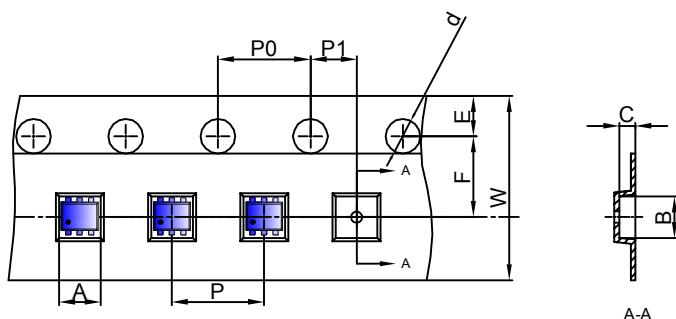
Note:  
 1. Controlling dimension:in millimeters.  
 2.General tolerance: $\pm 0.05$ mm.  
 3.The pad layout is for reference purposes only.

### NOTICE

JCET reserve the right to make modifications,enhancements, improvements, corrections or other changes without further notice to any product herein.JCET does not assume any liability arising out of the application or use of any product described herein.

## **SOT-563 Tape and reel**

### **SOT-563 Embossed Carrier Tape**

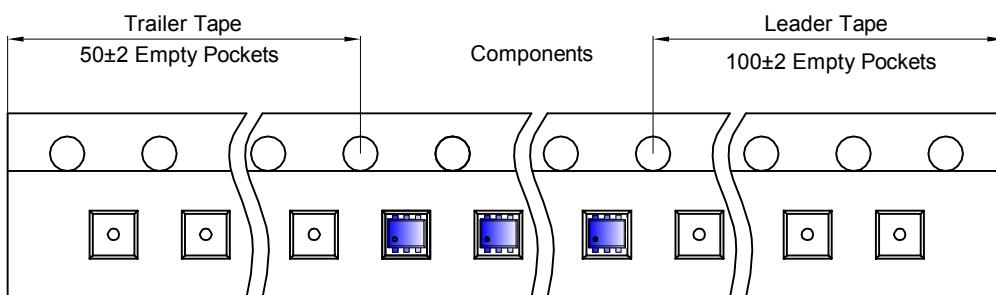


#### Packaging Description:

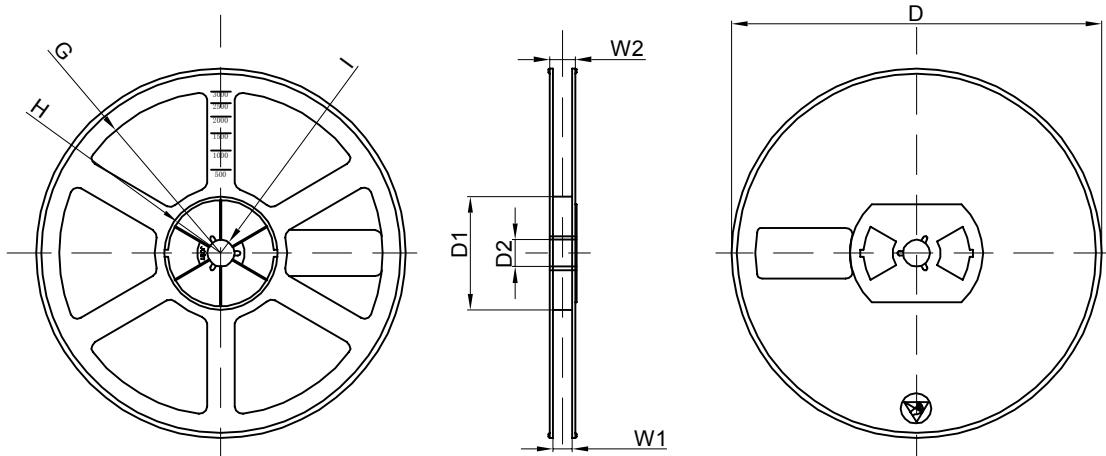
SOT-563 parts are shipped in tape. The carrier tape is made from a dissipative (carbon filled) polycarbonate resin. The cover tape is a multilayer film (Heat Activated Adhesive in nature) primarily composed of polyester film, adhesive layer, sealant, and anti-static sprayed agent. These reeled parts in standard option are shipped with 3,000 units per 7" or 17.8cm diameter reel. The reels are clear in color and is made of polystyrene plastic (anti-static coated).

Dimensions are in millimeter										
Pkg type	A	B	C	d	E	F	P0	P	P1	W
SOT-563	1.78	1.78	0.69	Ø1.50	1.75	3.50	4.00	4.00	2.00	8.00

### **SOT-563 Tape Leader and Trailer**



### **SOT-563 Reel**



Dimensions are in millimeter								
Reel Option	D	D1	D2	G	H	I	W1	W2
7" Dia	Ø178.00	54.40	13.00	R78.00	R25.60	R6.50	9.50	12.30

REEL	Reel Size	Box	Box Size(mm)	Carton	Carton Size(mm)	G.W.(kg)
3000 pcs	7 inch	30,000 pcs	203×203×195	120,000 pcs	438×438×220	